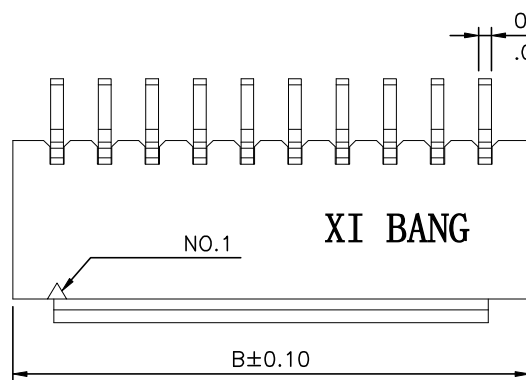
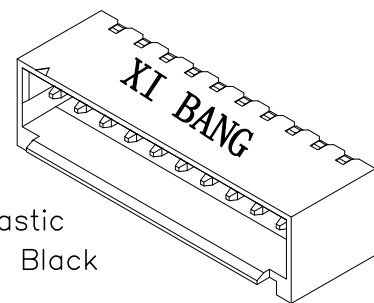




Notes:

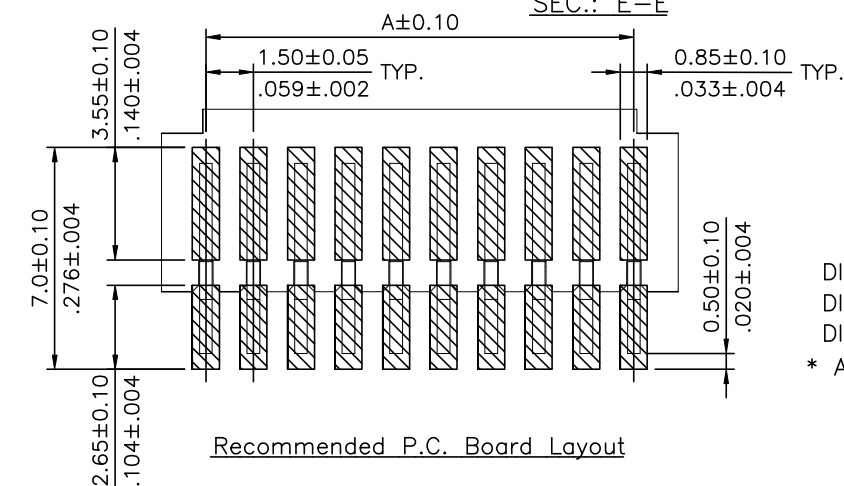
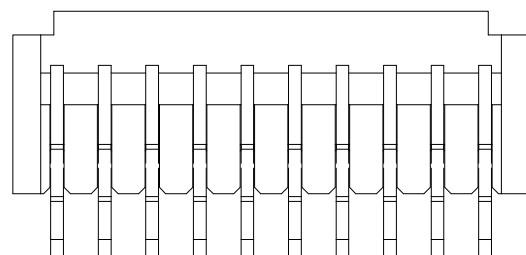
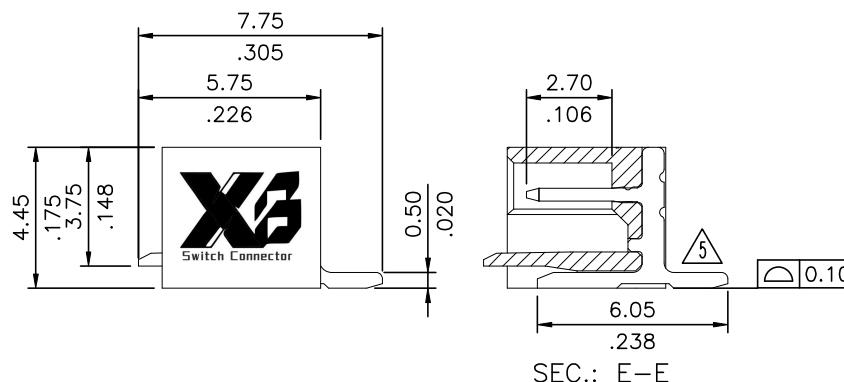
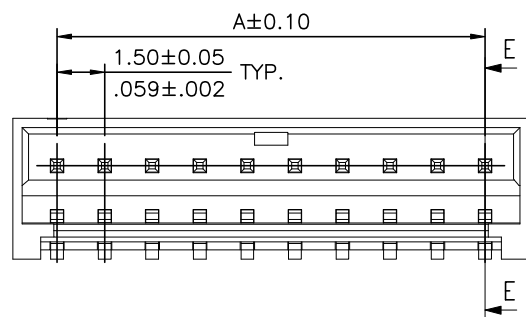
- ④ * Insulator: Halogen Free Plastic
UL 94V-0 Color Black
- * Contact: Copper alloy
- * For Lead-Free IR Reflow process



ORDERING CODE

CI19 ** M * H RO -NH
① ② ③ ④ ⑤ ⑥ ⑦

- ① Series No.
- ② Contact: 02 to 20
- ③ M= SMT Type
- ④ Plating :
1= 2.54μm(100μ") Min. Matte Tin
Plating on Contact area and
Solderails, 1.27μm(50μ") Nickel
Underplating over all
2= 0.03μm(1.2μ") Min. Gold Flash
Plating on Contact area and
Solderails, 1.27μm(50μ") Nickel
Underplating over all
3= 0.38μm(15μ") Min. Gold Plating
on Contact area and Solderails,
1.27μm(50μ") Nickel Underplating
over all
- ⑤ Contact type: H= Side entry
- ⑥ Packing option:
RO= Tape & Reel Packing
- ⑦ -NH= For Lead Free IR Processes and
Halogen-Free



DIM. A = 1.50 x NO. OF SPACES
DIM. B = DIM. A + 3.3
DIM. C = DIM. A + 1.8

* AVAILABLE IN 2 THROUGH 20

Halogen-Free

Lead Free Process

RoHS Compliant

⑦	Jack	12/29-23'	ECNT123179/ECRB123029		DATE	UNIT: mm / inch	TITLE: 1.5mm Pitch WTB SMT R/A TYPE
⑥	Ken	3/4-19'	ECNT119042/ECRH119006	DRAWN BY:	Jack	12/29-23'	TOLERANCE UNLESS OTHERWISE SPECIFIED
⑤	Ellie	1/5-15'	ECNT115001/ECRH114037	ENGINEER:	Sun	12/29-23'	
④	Ellie	9/29-14'	ECNT114212	CHECKED BY:	Eisley	12/29-23'	.X ± 0.30/.012 X' ± 1'
SYM	NAME	DATE	REVISIONS	APPROVED BY:	Eisley	12/29-23'	.XX ± 0.20/.008 X' ±
							.XXX ± 0.10/.004 XX' ±
MATERIAL:							
FINISH:							
DRAWING NO. CI1901SE PART NO. CI19**M*HR0-NH							
SCALE 4 / 1 SHEET 1 OF 2							



东莞市溪榜电子有限公司
DONG GUAN XI BANG ELECTRONICS CO., LTD.

